

General Description

This product family offers state of the art performance. It is designed for high frequency applications where high efficiency and high reliability are required.

Features

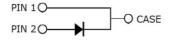
- Low conduction loss due to low VF
- Extremely low switching loss by tiny Qc
- Highly rugged due to better surge current
- Industrial standard quality and reliability

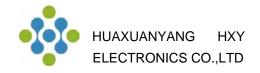
Applications

- UPS
- Power Inverter
- High performance SMPS
- Power factor correction

Ordering Part Number	Package	Marking	
HC3D10065E	TO-252-2L	HC3D10065E	





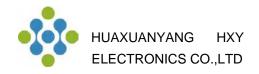


Maximum Ratings (at Tj = 25 °C, unless otherwise specified)

Parameter	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	Vrrm	650	V
Surge Peak Reverse Voltage	Vrsm	650	V
DC Peak Reverse Voltage	Vr	650	V
Continuous Forward Current			
Tc = 25°C Tc = 135°C Tc = 160°C	lF	30 15 10	A
Repetitive Peak Forward Surge Current $Tc = 25^{\circ}C, t_{p}=10ms, Half Sine Pulse$ $Tc = 110^{\circ}C, t_{p}=10ms, Half Sine Pulse$	Ifrm	45 27	A
Non-Repetitive Forward Surge Current $Tc = 25^{\circ}C, t_{p}=10ms, Half Sine Pulse$ $Tc = 110^{\circ}C, t_{p}=10ms, Half Sine Pulse$	IFSM	80 70	A
i²dt value Tc = 25°C,t _P =10ms,Half Sine Pulse Tc = 110°C,t _P =10ms,Half Sine Pulse	∫ i²dt	31.7 24.3	A²s
Power dissipation Tc = 25°C Tc = 110°C	Ptot	75 32	W
Operating junction Range	Tj	-55 to +175	°C
Storage temperature Range	Tstg	-55 to +150	°C

Thermal Resistance

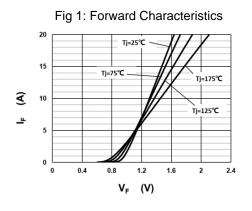
Parameter	Symbol	Value	Unit
Thermal resistance, junction – case.	RthJC	2.0	°C/W

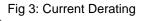


Parameter	Symbol		Value		Unit	Test Condition
	Symbol	min.	typ.	max.	Unit	rest condition
						I⊧=10A
Forward Voltage	VF	-	1.3	1.5	V	Tj=25°C
		-	1.5	-		Tj=175°C
						Vr=650V
Reverse Current	IR	-	-	50	μA	Tj=25°C
		-	-	200		Tj=175°C
						V ≈=400V,T j =25 ℃
Total Capacitive Charge	Qc	-	28	-	nC	$Q_{C} = \int_{0}^{V_{R}} C(V) dV$
						Tj =25 ℃, f=1MHz
		-	562	-	_	Vr=0V
Total Capacitance	С	-	56	-	pF	VR=200V
		-	44	-		V _R =400V

Electrical Characteristic (at Tj = 25 °C, unless otherwise specified)

Characteristics Curve:





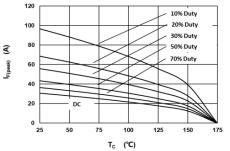
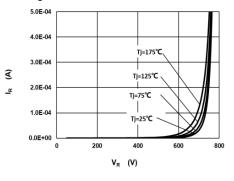
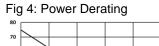
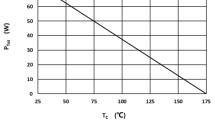


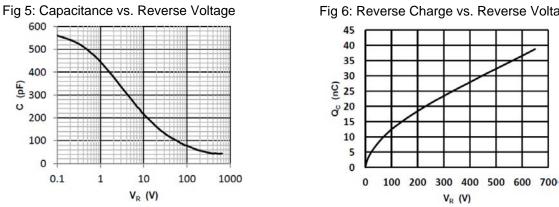
Fig 2: Reverse Characteristics

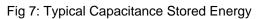


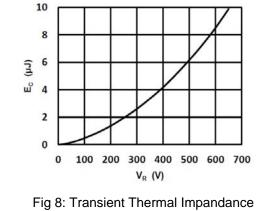


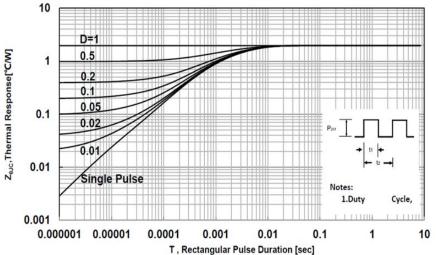


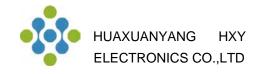






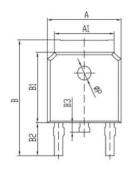




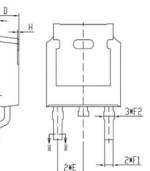


Package Dimensions

Package TO-252-2L

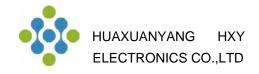


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-755 121	规范(mm)		
项目	MIN	MAX	
A	6.50	6.70	
A1	5.16	5.46	
В	9.77	10.17	
B1	6.00	6.20	
B2	2.60	3.00	
B3	0.70	0.90	
С	0.45	0.61	
D	2.20	2.40	
E	2.186	2.386	
F1	0.67	0.87	
F2	0.76	0.96	
Н	0.00	0.30	
h	0.00	0.127	
L	6.50	6.70	
φP	1.10	1.30	



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